Si4401FDY

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Vishay Siliconix



2 S 1 S Top View					
PRODUCT SUMMARY					
V _{DS} (V)	-40				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0142				
$R_{DS(on)}$ max. (Ω) at V_GS = -4.5 V	0.0183				
Q _g typ. (nC)	31				
I _D (A)	-14				
Configuration	Single				

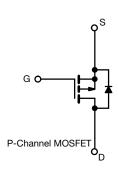
FEATURES

P-Channel 40 V (D-S) MOSFET

- TrenchFET[®] Gen III p-channel power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Adapter switch
- Load switch
- Battery switch
- Motor drive control



RoHS

COMPLIANT

HALOGEN

FREE

ORDERING INFORMATION

Package	SO-8
Lead (Pb)-free and halogen-free	Si4401FDY-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-40	V	
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		-14		
Continuous drain surrent (T 150 °C)	T _C = 70 °C	1 . [-11		
Continuous drain current (T _J = 150 °C)	T _A =25 °C	I _D	-9.9 ^{b, c}		
	T _A = 70 °C	1	-7.9 ^{b, c}	Α	
Pulsed drain current (t = 100 µs)		I _{DM}	-80 ª	A	
Continuous source-drain diode current	T _C = 25 °C		-4.5		
	T _A = 70 °C	I _S	-2.2 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	20		
Single pulse avalanche energy	L = 0.1 mm	E _{AS}	20	mJ	
Maximum power dissipation	T _C = 25 °C		5		
	T _C = 70 °C		3.2	w	
	T _A = 25 °C	P _D	2.5 ^{b, c}	vv	
	T _A = 70 °C	1	1.6 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature)			260		

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	40	50	°C/W		
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	21	25	- C/W		

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 85 °C/W

e. T_C = 25 °C

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-33	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μΑ	-	4.7	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-	-2.3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
7		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μΑ	
Zero gate voltage drain current	I _{DSS}	V _{DS} = -40 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \leq -5 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-10	-	-	А	
		V _{GS} = -10 V, I _D = -10 A	-	0.0118	0.0142	- Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -4.5 V, I _D = -10 A	-	0.0150	0.0183		
Forward transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -10 A	-	45	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	4000	-	pF	
Output capacitance	C _{oss}	V _{DS} = -20 V, V _{GS} = 0 V, f = 1 MHz	-	280	-		
Reverse transfer capacitance	C _{rss}		_	270	-		
Total gate charge	Q _g	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	_	66	100		
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	-	31	47	nC	
Gate-source charge	Q _{gs}		-	9.8	-		
Gate-drain charge	Q _{gd}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	_	10	-	1	
Gate resistance	R _g	f = 1 MHz	0.5	1.6	3	Ω	
Turn-on delay time	t _{d(on)}		-	12	24	-	
Rise time	t _r	V _{DD} = -20 V, R _I = 2 Ω, I _D ≅ -10 A,	-	6	12		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	44	88		
Fall time	t _f		-	6	12		
Turn-on delay time	t _{d(on)}		-	27	54	ns	
Rise time	t _r	V _{DD} = -20 V, R _I = 2 Ω, I _D ≅ -10 A,	-	75	150	-	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	39	78		
Fall time	t _f		-	39	78		
Drain-Source Body Diode Characteristi	cs				L	1	
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	-4.5		
Pulse diode forward current	I _{SM}	~ ~	-	-	-80	A	
Body diode voltage	V _{SD}	I _S = -5 A, V _{GS} = 0 V	-	-0.77	-1.1	V	
Body diode reverse recovery time	t _{rr}		-	24	48	ns	
Body diode reverse recovery charge	Q _{rr}		-	16	32	nC	
Reverse recovery fall time	t _a	I _F = -10 A, di/dt = 100 A/μs, T _J = 25 °C	-	12	-		
Reverse recovery rise time	t _b		-	12	_	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

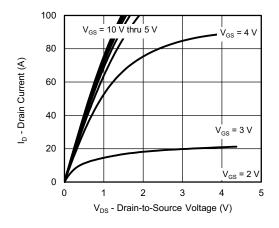
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

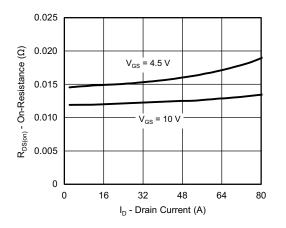
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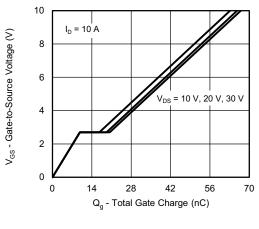
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



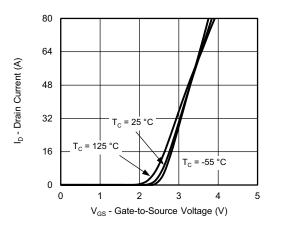
Output Characteristics



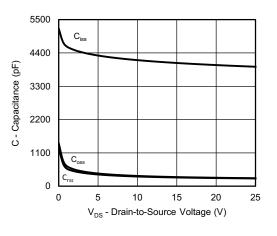
On-Resistance vs. Drain Current and Gate Voltage



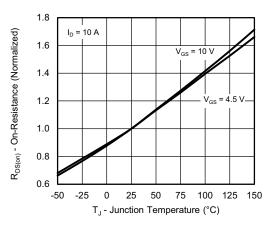
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

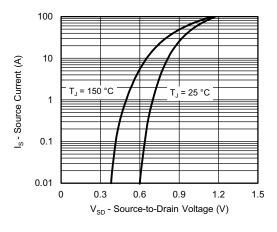
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3 s. contact: pmostechs Document Number: 75996

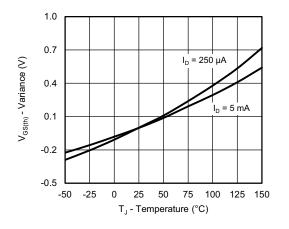
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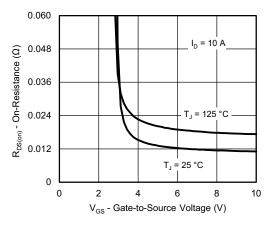
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



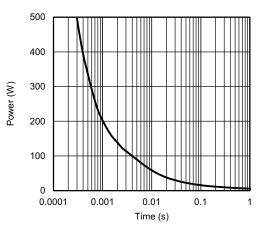
Source-Drain Diode Forward Voltage



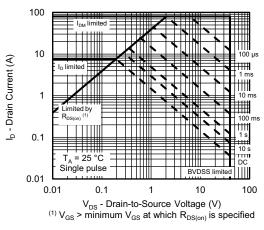
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



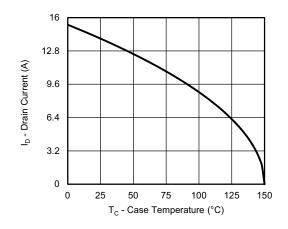
Safe Operating Area, Junction-to-Ambient

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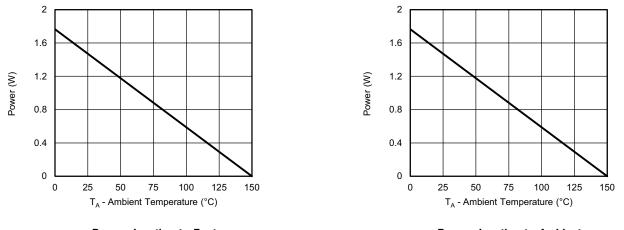
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Power, Junction-to-Foot

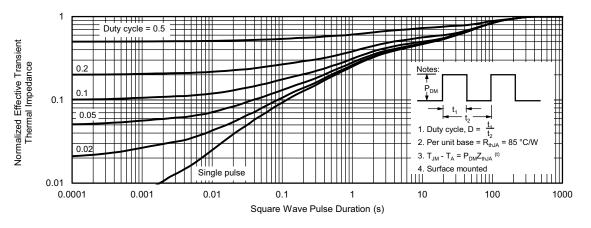
Power, Junction-to-Ambient

Note

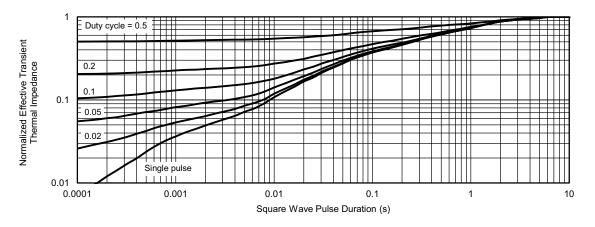
a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75996.

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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